



SCKBT-3000 KABUTO 3

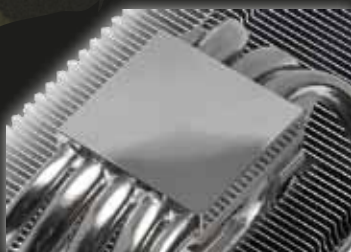


TECHNICAL DATA

Weight	720 g / 25.39 oz (incl. fan)
Dimensions (W x H x D)	130 x 125 x 149 mm (incl. fan) 5.12 x 4.92 x 5.86 in
Fan Dimensions	120 x 120 x 25 mm 4.72 x 4.72 x 0.98 inch
Fan Speed	300 ⁽⁺³⁰⁰⁾ ₍₋₂₀₀₎ ~ 1400 (±10%) rpm
Noise Level	4.0 ~ 28.0 dBA
Air Flow	21.96 ~ 113.34 m ³ /h 12.93 ~ 79.00 CFM
Static Air Pressure	0.07 ~ 1.56 mmH ₂ O 0.69 ~ 15.30 Pa
Compatibility	Intel® LGA 775/1150/1151/ 1155/1156/1366 AMD® AM2(+), AM3(+), FM1, FM2(+)

Hybrid Heatpipes

Kabuto 3 uses a hybrid system which consists of two 6 mm and three 8 mm heatpipes. The nickel-plated copper base-plate is carefully manufactured to exactly fit the heatpipes, resulting in an improved heat transfer and an overall better performance.



ACCESSORIES

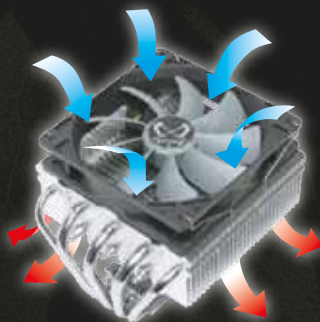
2x push-pin brackets (Intel mounting), AMD bracket, 2x screws, mounting bar, thermal grease, installation manual.

LOGISTICAL DATA

Item Number	SCKBT-3000
EAN UPC	4571225055596 812623020743
Package Weight	1020 g
Package Size	145 x 208 x 165 mm
Carton Info (W x D x H)	8 pcs / 10,2 kg 690 x 205 x 425 mm

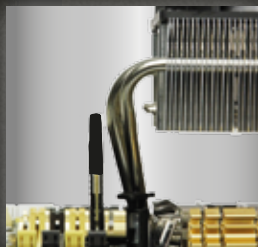
Top-Flow-Design

The downward airflow ventilates not only the heatsink fins of Kabuto 3, but also cools VRMs, memory modules, as well as other components surrounding the processor socket. This helps to prevent heat accumulation and increases the mainboards lifetime.



Increased compatibility

Special design as well as the improved arrangement and shape of the heatpipes of Kabuto 3 allows mounting even in compact cases. The free space between motherboard and heatsink provides excellent compatibility to large memory modules or VRM coolers.



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